



IEEE Women in Engineering Congress 2009 WIE'CON '09

“Meeting the global challenges of the next generation”

Date:

23 & 24th Oct 2009

Place:

Bangalore, India

Venue:

Sri Venkateswara College of Engineering, Bangalore

Organized by:

IEEE Bangalore Section ,
Bangalore

To register, please RSVP :

First Name Last Name at
ieewie.blr@gmail.com

Payment by DD in favour of
IEEE Bangalore section,
payable at Bangalore

“Meeting the global challenges of the next generation”

The Congress will focus on global challenges faced by the next generation and is intended to involve WIE Members, Scientists, Engineers and Research students in a cohesive drive in various domains like technology, social responsibilities, energy, automobile & power sector.

■ Who Should Attend

- IEEE Members, Women engineers in particular, WIE Members, Scientists, Engineers and Research students who can directly interface with Women Entrepreneurs, Consultants, Industry Captains and Academicians to get a fair exposure to the experts and their expertise in their respective domains.
- Provides a platform for WIE Members, Scientists, Engineers and Research students to create a good network and relationship among them, which can be leveraged for years to come.

■ Why IEEE WIE Congress 2009 in Bangalore?

- Technopolis of India
- Talented resources, good educational institutions and technological prowess.
- Bangalore is considered as the Silicon Valley of India, the IT Capital of India, the garden city of India which can boast of having the best R&D Institutions, R&D intensive Industries, academic
- A hub of Women Engineers and entrepreneurs.

■ Proposed Venue /Accommodation

Sri Venkateswara College Of Engineering, NH 7, Vidya Nagar Cross, Near Yelahanka Air force Station NH7, Bangalore, Karnataka 562157



Celebrating 125 Years
of Engineering the Future

Call for Papers in the following areas: Full papers no longer than 4 pages of A4 size in word format may be submitted by 30 Jun 09 by email alongwith topic chosen to

ieewie.blr@gmail.com

All submissions must be in English only.

Criteria for submission: Atleast one IEEE-WIE/girl student member or woman (non-IEEE member/non-IEEE student member) as author/co-author.

Aeronautics

- Aerospace innovation through re configurable Electronics

Biotechnology

- Emerging trends in Bio detection technologies
- Trends in Bioprocess engineering
- Biomedical Engineering
- Challenges in bio computing

Business & Innovations

- Modern management Practices & Information Technology Trends
- Business architecture

Energy

- Smart Grid applications
- Fuel Cells & Green Power
- Power electronics – connecting to future energy

Information Technology

- Research challenges in Information science

Nanotechnology

- Global challenges in Nano science

Wireless

- Cognitive Radio Oriented Wireless Networks and Communications
- Wireless Communications, Networking and Mobile Computing
- Wireless Sensor technology

▪ **Registration: WIE/IEEE/Non-IEEE members & IEEE/Non-IEEE Student members**

IEEE-WIE members	INR 1,250
IEEE members	INR 1,500
Non IEEE members	INR 2,000
IEEE Student members	INR 750
Non IEEE Student Members	INR 1,000

▪ **Registration : International Participants**

International Participants	\$100.00
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▪ **Congress sponsors are welcome**

Provides a platform for visibility among WIE Members, Scientists, Engineers and Research students across various domains like nanotechnology, biotechnology, energy, automobile, power and telecom sectors.

For sponsorship please contact convener.

▪ **Committee for IEEE WIE Congress 2009**

- General Chair Mr. Ramakrishna K, Chairman, IEEE Bangalore Section
- Organizing Chair Dr. Ramalatha Marimuthu, R10 WIE Coordinator & Chair, WIE IEEE Chennai Section.
- Convener Dr. YVS Lakshmi Chair, WIE IEEE Bangalore Section.

▪ **Important Dates**

June 30th 09– Full Paper Submission deadline

July 30th 09– Paper acceptance and intimation

August 20th 09– Last date for registration for Congress participation

Oct 23 & 24 2009 IEEE WIE Congress 2009